MN39217FH

Diagonal 4.5 mm (type-1/4) 320k-pixel CCD Area Image Sensor

Overview

The MN39217FH is a 4.5 mm (type-1/4) interline transfer CCD (IT-CCD) solid state image sensor device.

This device uses photodiodes in the optoelectric conversion section and CCDs for signal readout. The electronic shutter function has made an exposure time of 1/10000 seconds possible. Further, this device has the features of high sensitivity, low noise, broad dynamic range, and low smear.

This device has a total of 320589 pixels (537 horizontal \times 597 vertical) and provides stable and clear images with a resolution of 330 horizontal TV-lines and 420 vertical TV-lines.

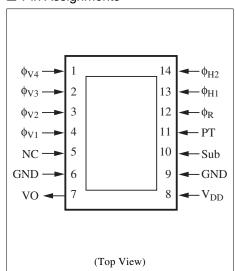
Part Number	Size	System	Color or B/W		
MN39217FH	4.5 mm (type-1/4)	PAL	Color		

Features

- Effective pixel number 500 (horizontal) × 582 (vertical)
- High sensitivity
- Broad dynamic range
- Low smear
- Electronic shutter

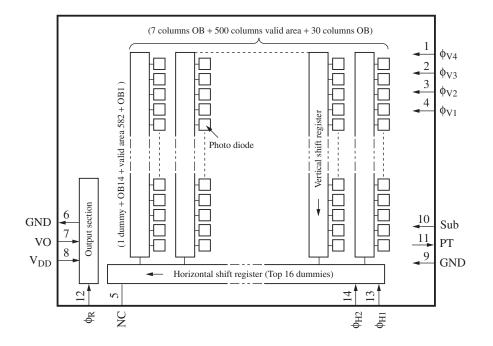
Applications

- Serveillance cameras
- FA, OA cameras



Pin Assignments

Block Diagram



Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	ϕ_{V4}	Vertical shift register clock pulse 4	8	V _{DD}	Power supply
2	ϕ_{V3}	Vertical shift register clock pulse 3	9	GND	GND
3	ϕ_{V2}	Vertical shift register clock pulse 2	10	Sub	Substrate
4	ϕ_{V1}	Vertical shift register clock pulse 1	11	PT	P-well for protection circuit
5	NC	NC	12	φ _R	Reset pulse (RG)
6	GND	GND	13	φ _{H1}	Horizontal register clock pulse 1
7	VO	Video output	14	φ _{H2}	Horizontal register clock pulse 2

$\blacksquare Device Parameter (H \times V)$

Parameter	Value	Unit		
Pixel number *	500×582	pixel		
Image sensing block dimension	3.599×2.698	mm ²		
Pixel dimension	7.30×4.70	μm^2		

Note) *: OB columns are not included.

■ Absolute Maximum Ratings and Operating Conditions

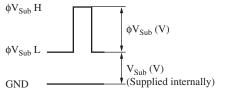
_		Absolute max	kimum rating	Op					
Parameter		Lower limit	Upper limit	Min	Тур	Max	Unit		
V _{DD}		- 0.2	18.0	14.5	15.0	15.5	V		
V _{PT} *3, 4		-10.0	0.2	-8.3	-8.0	-7.7	V		
GND		(Reference voltage)			0		v		
$V_{\phi R}$	High-Low		8.0	3.0	3.3	3.6	V		
	Bias		(S	upplied internal	ly)		V		
$V_{\phi H1}$	High	_	8.0	3.0	3.3	3.6	V		
	Low	- 0.2		- 0.05	0	0.05	V		
$V_{\phi H2}$	High	_	8.0	3.0	3.3	3.6	V		
	Low	- 0.2		- 0.05	0	0.05	V		
V _{Sub} *2		(Supplied internally)							
$\phi V_{Sub}{}^{*1}$		- 0.2	45.0	22.0	23.0	24.0	V		
V _{\$\phiV1} *3, 4	High	—	18.0	14.5	15.0	15.5	V		
	Middle	—	_	- 0.2	0	0.2	V		
	Low	-9.0	_	-8.3	-8.0	-7.7	V		
$V_{\phi V2} * 3, 4$	Middle	_	15.0	- 0.2	0	0.2	V		
	Low	-9.0	_	-8.3	-8.0	-7.7	V		
V _{\$\phiV3} *3, 4	High	—	18.0	14.5	15.0	15.5	V		
	Middle	—	_	- 0.2	0	0.2	V		
	Low	-9.0	_	-8.3	-8.0	-7.7	V		
$V_{\varphi V4} {}^{*3,4}$	Middle	—	15.0	- 0.2	0	0.2	V		
	Low	-9.0		-8.3	-8.0	-7.7	V		
Operating te	mperature	-10	60	_	25		°C		
Storage temp	perature	-30	80	_	_	_	°C		

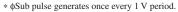
Absolute Maximum Ratings and Operating Conditions (continued)

Note) 1. Standard photo detecting condition

Standard photo detecting condition stands for detecting image with a light source of color temperature of 2 856K, luminance of 1 050 cd/m², and using a color temperature conversion filter LB-40 (HOYA), infrared cut filter CAW-500S with thickness 2.5 mm for a light path and with F8 lens aperture. The quantity of the incidental light to a photo-detecting surface under the above condition is defined as the standard quantity of light.

2. *1: V_{Sub} when using electronic shutter function





- *2: V_{Sub} supplied internally is the voltage suppressing the blooming generation at ×1 000 light quantity relative to the standard light quantity.
- *3: Relation between V_{PT} and $V_{\phi VL}$

Set V_{PT} under the following condition against VL of a vertical transfer clock waveform.

 $V_{PT} \le VL (V_{\phi V1L} \text{ to } V_{\phi V4L})$

*4: Absolute maximum ratings $-0.2 < V_{Sub} - V_{PT} < 55 (V)$ $-0.2 < V_{\phi V} - V_{PT} < 24.5 (V)$

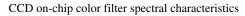
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
S/N ratio (dark)	S/Nd	Dark condition	57	60		dB
Sensitivity	So	So J chart F8		380		mV
	So	J chart F1.4	220	250		mV
Carrier saturation output	Sc	Carrier maximum output	550	600		mV
Vertical smear	Sm	1/10 V chart, F1.4			0.01	%

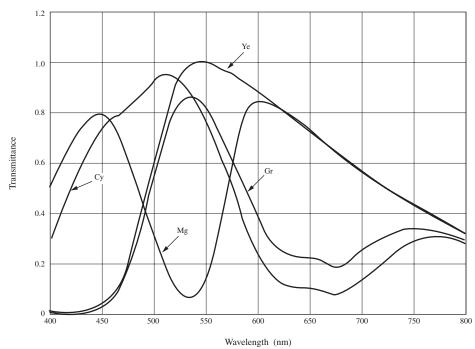
Optical Characteristics

Color Filter Arrays on CCD

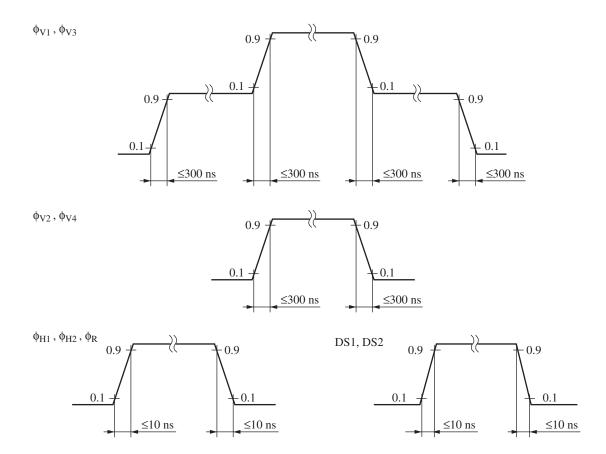
									$\overline{)}$			
582	Су	Ye	Су	Ye	Су	Ye	Су	Ye		Су	Ye	
581	Mg	G	Mg	G	Mg	G	Mg	G		Mg	G	
						\sim		\sim			\searrow	/
				$\left(\right)$	\searrow					\checkmark		/
									((
8	Су	Ye	Су	Ye	Су	Ye	Су	Ye		Су	Ye	
7	G	Mg	G	Mg	G	Mg	G	Mg		G	Mg	
6	Су	Ye	Су	Ye	Су	Ye	Су	Ye		Су	Ye	
5	Mg	G	Mg	G	Mg	G	Mg	G	$\overline{77}$	Mg	G	
4	Су	Ye	Су	Ye	Су	Ye	Су	Ye		Су	Ye	
3	G	Mg	G	Mg	G	Mg	G	Mg	$\overline{7}$	G	Mg	
2	Су	Ye	Су	Ye	Су	Ye	Су	Ye		Су	Ye	
1	Mg	G	Mg	G	Mg	G	Mg	G		Mg	G	
	1	2	3	4	5	6	7	8		499	500	

■ Graph of Characteristics

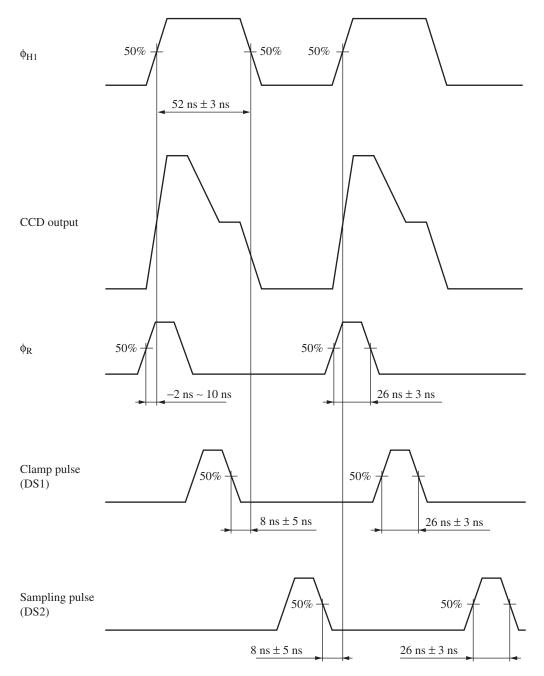




Timing Diagram

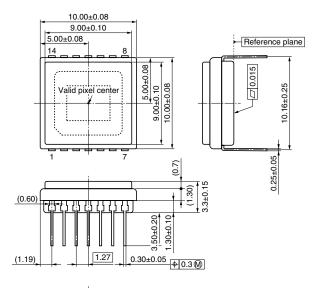


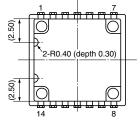
- Timing Diagram (continued)
- CMOS pulse timing



Package Dimensions (unit: mm)

• WDIP014-P-0400H





- 1. The center of the package is equal to the center of the effective pixel area.
- 2. The rotation angle of the effective pixel area: up to ± 1.0 degree
- 3. The distance from the bottom face of the package to the surface of the effective pixel area: 1.41 mm \pm 0.1 mm
- 4. The tilt of the effective pixel area for the bottom face of the package: up to 25 μm
- 5. Thickness of seal glass is 0.7 mm \pm 0.1 mm, and the refractive index is 1.50.
- 6. Package weight: 0.55 g (typ.)

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